

BB174 VHF variable capacitance diode Rev. 1 — 25 March 2013

**Product data sheet** 

## 1. Product profile

### 1.1 General description

The BB174 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD523 (SC-79) ultra small SMD plastic package.

### 1.2 Features and benefits

- Excellent linearity
- Ultra small SMD plastic package
- C<sub>d(28V)</sub> = 2.1 pF; C<sub>d(1V)</sub> to C<sub>d(28V)</sub> ratio = 9
- Low series resistance

### **1.3 Applications**

Voltage Controlled Oscillators (VCO)

## 2. Pinning information

Pin	Description	Simplified outline	Symbol
1	cathode	[1]	
2	anode 1 2	$\downarrow$	
			sym008

[1] The marking bar indicates the cathode.

## 3. Ordering information

### Table 2.Ordering information

Type number	Package			
	Name	Description	Version	
BB174	SC-79	plastic surface-mounted package; 2 leads	SOD523	



## 4. Marking

Table 3. Marking	
Type number	Marking code
BB174	CF

## 5. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>R</sub>	reverse voltage		-	30	V
		peak value in series with a 10 $k\Omega$ resistor	-	35	V
I <sub>F</sub>	forward current		-	20	mA
T <sub>stg</sub>	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

### 6. Characteristics

### Table 5.Characteristics

 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>R</sub>	reverse current	V <sub>R</sub> = 30 V	[1]	-	-	10	nA
		$V_R = 30 \text{ V}; \text{ T}_j = 85 ^{\circ}\text{C}$	[1]	-	-	200	nA
r <sub>s</sub>	diode series resistance	f = 470 MHz; C <sub>d</sub> = 9 pF		-	0.6	0.75	Ω
C <sub>d</sub>	diode capacitance	f = 1 MHz	[2]				
		V <sub>R</sub> = 1 V		18.22	-	21.26	pF
		V <sub>R</sub> = 28 V		1.951	2.1	2.225	pF
$C_{d(1V)}/C_{d(2V)}$	diode capacitance ratio (1 V to 2 V)	f = 1 MHz		-	1.27	-	
$C_{d(1V)}/C_{d(28V)}$	diode capacitance ratio (1 V to 28 V)	f = 1 MHz		8.45	9	10.9	
$C_{d(25V)}/C_{d(28V)}$	diode capacitance ratio (25 V to 28 V)	f = 1 MHz		-	1.05	-	

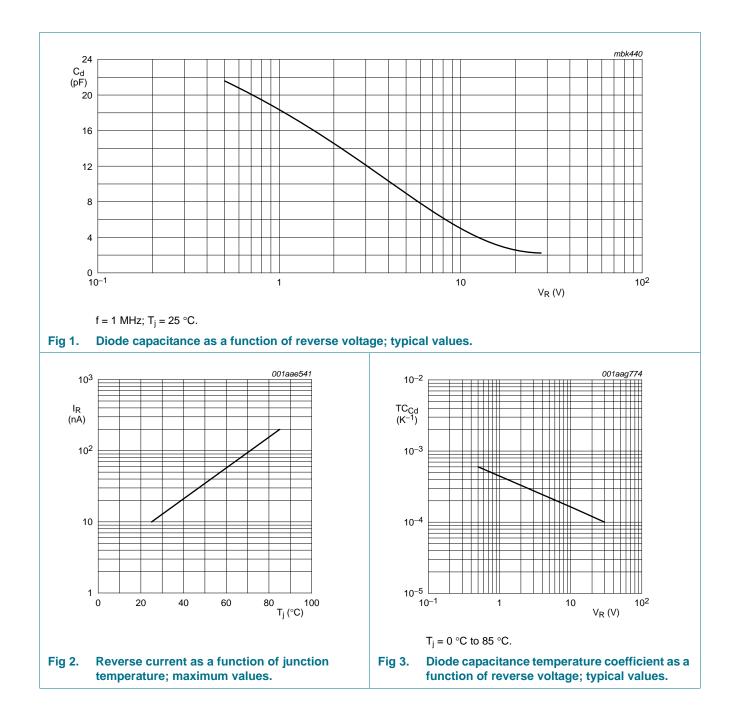
[1] See Figure 2.

[2] See Figure 1 and Figure 3.

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## 7. Package outline

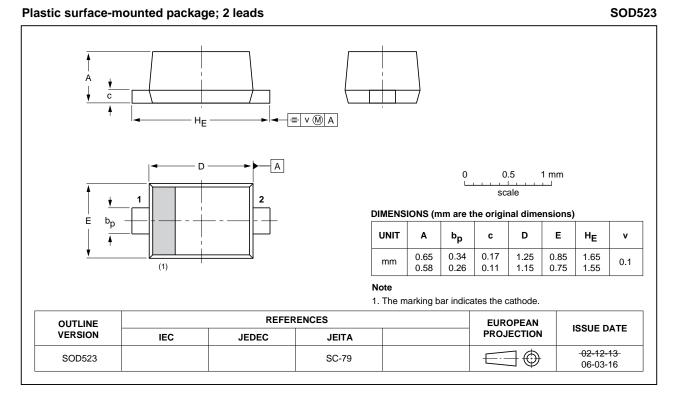


Fig 4. Package outline SOD523 (SC-79)

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## 8. Abbreviations

Table 6.	Abbreviations
Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

## 9. Revision history

Table 7. Revision his	tory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BB174 v.1	20130325	Product data sheet	-	-

## **10. Legal information**

### **10.1 Data sheet status**

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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